

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3931069

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KISHORE K.R. DEVIREDDY	05/18/2016
JOHN J. GLEN	05/31/2016
VENKATANARASIMHAN K. RAMAKRISHNAN	06/20/2016
JUSTIN R. UNGER	06/11/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HGST NETHERLANDS B.V.
<b>Street Address:</b>	HERIKERBERGWEG 238
<b>Internal Address:</b>	LUNA ARENA, 1101 CM
<b>City:</b>	AMSTERDAM
<b>State/Country:</b>	NETHERLANDS
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15189901
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)938-9069
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	408-938-9060
<b>Email:</b>	cholland@mhbpatents.com
<b>Correspondent Name:</b>	HGST C/O MURABITO, HAO & BARNES LLP
<b>Address Line 1:</b>	TWO NORTH MARKET STREET, THIRD FLOOR
<b>Address Line 4:</b>	SAN JOSE, CALIFORNIA 95113
<b>ATTORNEY DOCKET NUMBER:</b>	HGST-H20161015US1
<b>NAME OF SUBMITTER:</b>	JAMES P. HAO
<b>SIGNATURE:</b>	/James P. Hao/
<b>DATE SIGNED:</b>	06/22/2016
<b>Total Attachments: 4</b>	
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source=HGST-H20161015US1_Assignment#page3.tif	



## ASSIGNMENT FOR PATENT APPLICATION

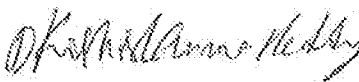
Whereas, I/we the undersigned inventor(s) have invented certain improvements as set forth in the patent application entitled:

### PROVISIONING THE HYPER-CONVERGED INFRASTRUCTURE BARE METAL SYSTEMS FROM THE TOP OF THE RACK SWITCH

Whereas, **HGST Netherlands B.V.**, having a place of business at, Herikerbergweg 238, Luna ArenA, 1101 CM Amsterdam, The Netherlands (hereinafter referred to as "HGST"), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to HGST, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HGST, its successors and assigns; and we hereby agree that HGST may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HGST.

Signed on the date(s) indicated beside my (our) signature(s).

- 
- 1) Signature: \_\_\_\_\_ Date: 05/18/2016  
Typed Name: **Kishore K. R. DEVIREDDY**
  - 2) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Typed Name: **John J. GLEN**
  - 3) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Typed Name: **Venkatanarasimhan K. RAMAKRISHNAN**
  - 4) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Typed Name: **Justin R. UNGER**

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- 1) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Typed Name: **Kishore K. R. DEVIREDDY**
- 2) Signature:  Date: May 31, 2016  
Typed Name: **John J. GLEN**
- 3) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Typed Name: **Venkatanarasimhan K. RAMAKRISHNAN**
- 4) Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
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- |    |  |                         |
|----|--|-------------------------|
| 1) | Signature: _____<br>Typed Name: <b>Kishore K. R. DEVIREDDY</b>   | Date: _____             |
| 2) | Signature: _____<br>Typed Name: <b>John J. GLEN</b>  | Date: _____             |
| 3) | Signature: <br>Typed Name: <b>Venkatanarasimhan K. RAMAKRISHNAN</b> | Date: <u>06/20/2016</u> |
| 4) | Signature: _____<br>Typed Name: <b>Justin R. UNGER</b>   | Date: _____             |

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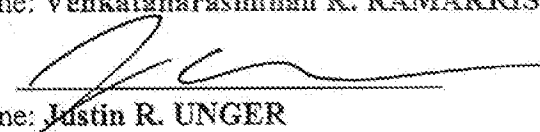
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- 4) Signature:  Date: 6/11/16  
Typed Name: Justin R. UNGER